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# **SUD40151EL**

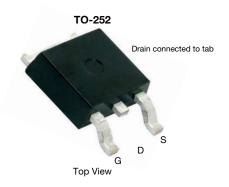
Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

## P-Channel 40 V (D-S) 175 °C MOSFET



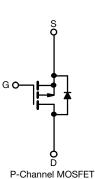
PRODUCT SUMMARY		
V <sub>DS</sub> (V)	-40	
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0120	
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0175	
Q <sub>g</sub> typ. (nC)	74.3	
I <sub>D</sub> (A) <sup>d</sup>	-42	
Configuration	Single	

### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV p-channel power MOSFET
- Maximum 175 °C junction temperature
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of FREE compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Motor drive control
- LED backlighting
- Load switch
- Industrial



ORDERING INFORMATION		
Package	TO-252	
Lead (Pb)-free and halogen-free	SUD40151EL-GE3	

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-40	N
Gate-source voltage		V <sub>GS</sub>	± 20	V
Continuous ducin current	T <sub>C</sub> = 25 °C		-42 <sup>d</sup>	
Continuous drain current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	-28.6	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-100	А
Continuous source-drain diode current		I <sub>S</sub>	-41.7	
Single pulse avalanche current <sup>a</sup>		I <sub>AS</sub>	-25	
Single pulse avalanche energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	31.25	mJ
T <sub>C</sub> = 25 °C			50 <sup>b</sup>	14/
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	16.7 <sup>b</sup>	W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	*
Soldering recommendations (peak temperature) <sup>c</sup>			260	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	MAXIMUM	UNIT
Maximum junction-to-ambient (PCB mount) <sup>c</sup>		R <sub>thJA</sub>	60	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	3	0/10

#### Notes

a. Duty cycle  $\leq$  1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

d. Package limited

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Document Number: 75668

**SUD40151EL** 

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-40	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-1.5	-	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	250	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = -40 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C	-	-	-150		
		$V_{DS}$ = -40 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C	-	-	-5	mA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ -10 V, $V_{GS}$ = -10 V	-30	-	-	Α	
Drain aguras en stata registance à	D	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -17.5 A	-	0.0100	0.0120		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -14.5 A	-	0.0135	0.0175	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -17.5 A	-	70	-	S	
Dynamic <sup>b</sup>			•		•	•	
Input capacitance	Ciss		-	5340	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	335	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	303	-		
Total gate charge	Qg		-	74.3	112	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -20 V, $V_{GS}$ = -10 V, $I_D$ = -17.5 A	-	12.7	-		
Gate-drain charge	Q <sub>gd</sub>		-	11.1	-		
Gate resistance	Rg	f = 1 MHz	0.86	4.3	8.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	15	30		
Rise time	t <sub>r</sub>	$V_{DD}$ = -20 V, R <sub>L</sub> = 1.4 Ω, I <sub>D</sub> $\cong$ -14 A,	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	75	113	ns	
Fall time	t <sub>f</sub>		-	75	113		
Drain-Source Body Diode Characteristic	cs		•		•	•	
Pulse diode forward current (t = 100 $\mu$ s)	I <sub>SM</sub>		-	-	-42	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>F</sub> = -14 A, V <sub>GS</sub> = 0 V	-	-0.85	-1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	30	45	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	L = 14.0  di/dt = 100.0  h/m	-	0.02	0.04	μC	
Reverse recovery fall time	ta	I <sub>F</sub> = -14 A, di/dt = 100 A/μs	-	15.3	-		
Reverse recovery rise time	t <sub>b</sub>		-	14.7	-	ns	
Body diode peak reverse recovery charge	I <sub>RM(REC)</sub>		-	-	2.8	Α	

Notes

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

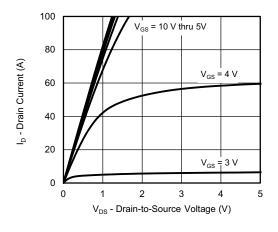
b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

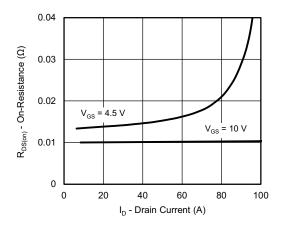
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



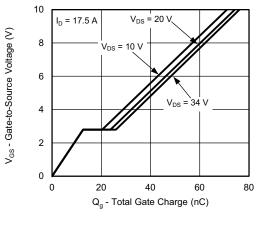
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



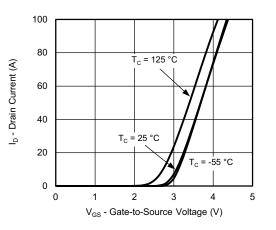
**Output Characteristics** 



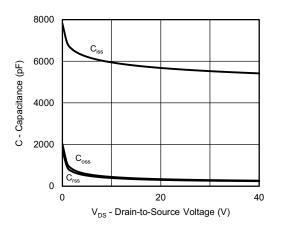
**On-Resistance vs. Drain Current and Gate Voltage** 



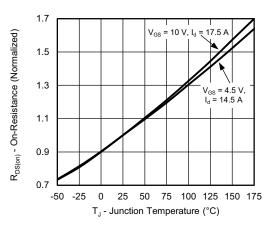




**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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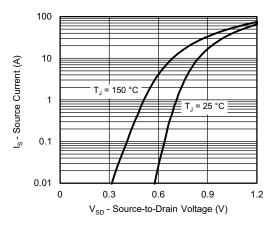
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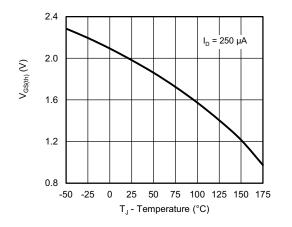
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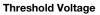


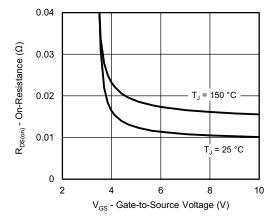
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



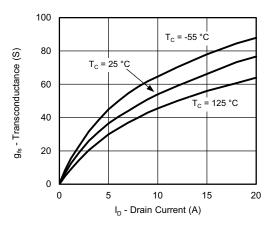
Source-Drain Diode Forward Voltage



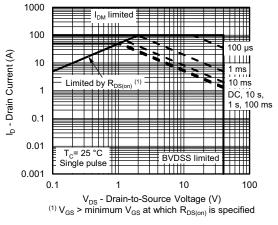




**On-Resistance vs. Gate-to-Source Voltage** 



Transconductance



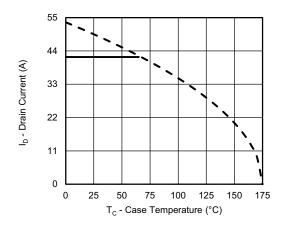
Safe Operating Area, Junction-to-Ambient

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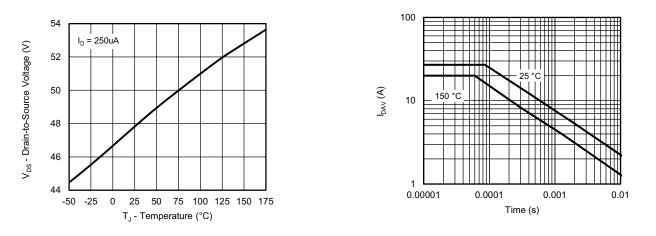
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating <sup>a</sup>



Drain Source Breakdown vs. Junction Temperature

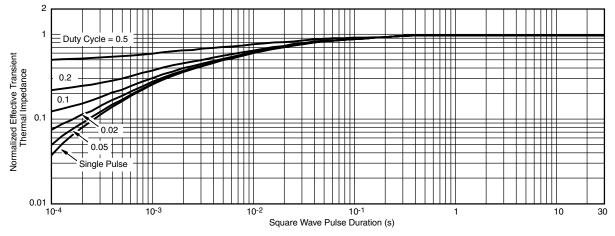
I<sub>DAV</sub> vs. Time

#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

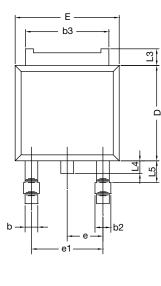
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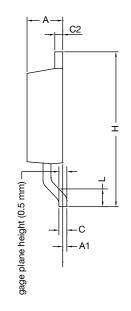


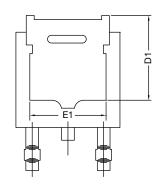


**TO-252AA Case Outline** 

## VERSION 1: FACILITY CODE = Y







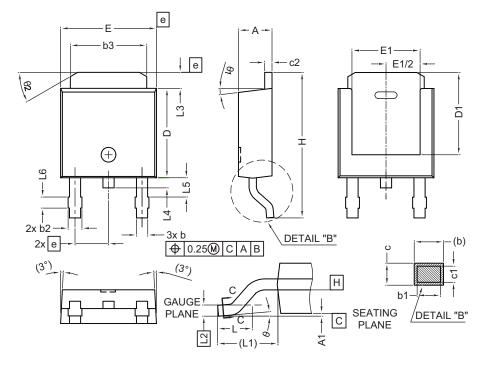
	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56	BSC	
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



## VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
e	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0° 15°		
θ2	25° 35°		

#### Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

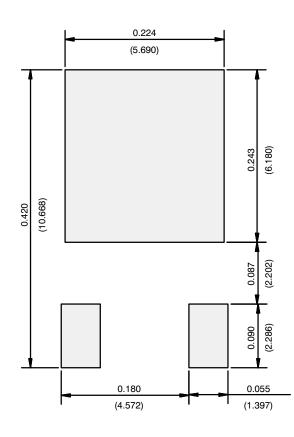
Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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